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<u>Texas Instruments</u> <u>SN74ABT16540ADGVR</u>

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Datasheet of SN74ABT16540ADGVR - IC INVERTER DUAL 8-INPUT 48TVSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

### SN54ABT16540, SN74ABT16540A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS208C - FEBRUARY 1991 - REVISED APRIL 1997

- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V<sub>OLP</sub> (Output Ground Bounce)
   1 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>)
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages, and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

#### description

The SN54ABT16540 and SN74ABT16540A are inverting 16-bit buffers/drivers composed of two 8-bit sections with separate output-enable gates. These buffers and bus drivers provide a high-performance bus interface for wide data paths.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable (OE1 or OE2) input is high, all corresponding outputs are in the high-impedance state.

SN54ABT16540 . . . WD PACKAGE SN74ABT16540A . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)

1		1 1		1
10E1	1	$\cup$	48	10E2
1Y1 🛚	2		47	1A1
1Y2	3		46	1A2
GND	4		45	GND
1Y3 🛚	5		44	1A3
1Y4	6		43	1A4
v <sub>cc</sub> L	7		42	₽ v <sub>cc</sub>
1Y5 🖣	8		41	1A5
1Y6 L	9		40	1A6
GND	10		39	GND
1Y7 🖣	11		38	1A7
1Y8 L	12		37	_
2Y1	13		36	
2Y2	14		35	
GND	15		34	
2Y3 L	16			2A3
2Y4 L	17		32	
v <sub>cc</sub> _	18		31	₽v <sub>cc</sub>
2Y5 🛚	19		30	
2Y6 L	20			2A6
GND [	21		28	
2Y7 🛚	22		27	2A7
2Y8 L	23		26	2 <u>A8</u>
20E1	24		25	2 <mark>0E2</mark>
l l				•

To ensure the high-impedance state during power up or power down,  $\overline{\text{OE}}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16540 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT16540A is characterized for operation from –40°C to 85°C.



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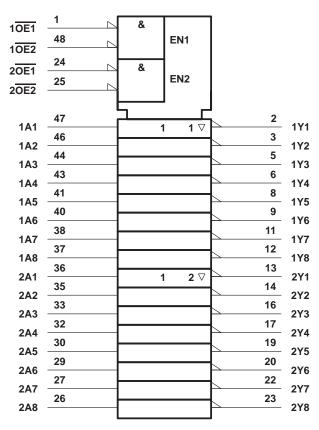
# SN54ABT16540, SN74ABT16540A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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# FUNCTION TABLE (each 8-bit section)

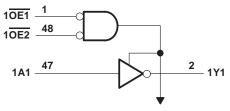
	INPUTS	OUTPUT	
OE1	OE2	Α	Y
L	L	L	Н
L	L	Н	L
Н	X	Χ	Z
Х	Н	Χ	Z

### logic symbol†

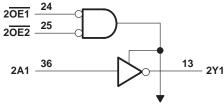


<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### logic diagram (positive logic)



To Seven Other Channels



To Seven Other Channels

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## SN54ABT16540, SN74ABT16540A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	0 5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, Vo	–0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT16540	
SN74ABT16540A	128 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–18 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package	
DGV package	93°C/W
DL package	94°C/W
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions (see Note 3)

			SN54AB	Г16540	SN74ABT1	6540A	UNIT
			MIN	MAX	MIN	MAX	ONIT
Vcc	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2	EM	2		V	
V <sub>IL</sub>	V <sub>IL</sub> Low-level input voltage					0.8	V
VI	Input voltage		0.0	VCC	0	Vcc	V
loh	High-level output current		ζ)	-24		-32	mA
loL	Low-level output current		200	48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled	B	10		10	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.



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### SN54ABT16540, SN74ABT16540A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADA	METER	TEST CO	NOITIONS	Т	A = 25°C	;	SN54AB1	Γ16540	SN74ABT1	16540A	UNIT
PARA	METER	lesi co	NDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	MAX	MIN	MAX	UNII
VIK		V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = -18 mA			-1.2		-1.2		-1.2	V
V <sub>CC</sub> = 4.5 V,		I <sub>OH</sub> = -3 mA	2.5			2.5		2.5			
\/a		$V_{CC} = 5 V$ ,	I <sub>OH</sub> = -3 mA	3			3		3		V
VOH		V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = -24 mA	2			2				V
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*					2		
VOL		V <sub>CC</sub> = 4.5 V	$I_{OL} = 48 \text{ mA}$			0.55		0.55			V
VOL		VCC = 4.5 V	$I_{OL} = 64 \text{ mA}$			0.55*				0.55	V
V <sub>hys</sub>					100						mV
lį		$V_{CC} = 5.5 \text{ V},$	$V_I = V_{CC}$ or GND			±1		<u>±</u> 1		±1	μΑ
lozh		$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 2.7 V			10		50		10	μΑ
lozL		$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 0.5 V			-10		<del>-</del> 50		-10	μΑ
l <sub>off</sub>		$V_{CC} = 0$ ,	$V_I$ or $V_O \le 4.5 \text{ V}$			±100	1	ζ		±100	
ICEX		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high			50	nac	50		50	μΑ
IO <sup>‡</sup>		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.5 V	<b>-</b> 50	-100	-180	50	-180	-50	-180	mA
		V <sub>CC</sub> = 5.5 V,	Outputs high			3		2		3	
Icc		$I_{O} = 0$ ,	Outputs low			34		32		34	mA
		$V_I = V_{CC}$ or GND	Outputs disabled			3		2		3	
	Data	V <sub>CC</sub> = 5.5 V, One input at 3.4 V,	Outputs enabled			1		1		1	
ΔICC§	inputs	Other inputs at VCC or GND	Other inputs at			0.05		0.05	mA		
	Control inputs	V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND				1.5		1.5		1.5	
Ci		V <sub>I</sub> = 2.5 V or 0.5 V			3.5						pF
Co		V <sub>O</sub> = 2.5 V or 0.5 V			7.5						рF

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM TO (INPUT)		V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			SN54AB	Γ16540	SN74ABT	UNIT	
	(INFOT)	(0011-01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	А	V	1	2.3	3.3	1	4.2	1	4.1	ns
<sup>t</sup> PHL	A	T	1.1	2.5	4.1	1.1	4.4	1.1	4.3	115
<sup>t</sup> PZH	<u>OE</u>	Y	1.1	3.1	4.2	1.1	5.2	1.1	5.1	no
<sup>t</sup> PZL	OE		1.6	3.7	4.8	1.6	6	1.6	5.9	ns
<sup>t</sup> PHZ	ŌĒ	Y	1.6	4	5	01.6	5.4	1.6	5.7	nc
t <sub>PLZ</sub>	OE		1.4	3.2	4.4	2 1.4	4.7	1.4	4.7	ns



<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ .

<sup>‡</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

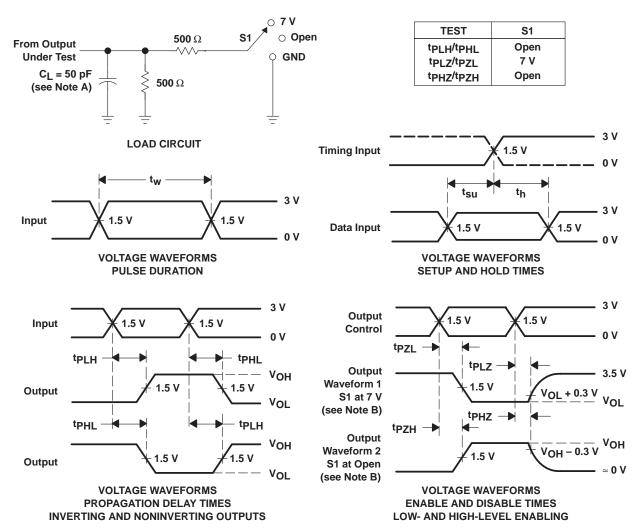
<sup>§</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.



### SN54ABT16540, SN74ABT16540A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_\Gamma \leq 2.5$  ns,  $t_f \leq 2.5$  ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





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#### PACKAGE OPTION ADDENDUM

18-Sep-2008

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finisl	h MSL Peak Temp <sup>(3)</sup>
74ABT16540ADGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ABT16540ADGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ABT16540ADGVRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ABT16540ADGVRG4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16540ADGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16540ADGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16540ADL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16540ADLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16540ADLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16540ADLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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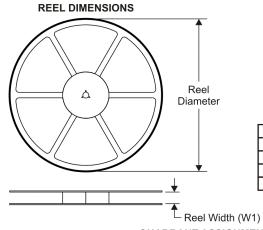
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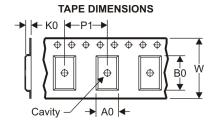


## PACKAGE MATERIALS INFORMATION

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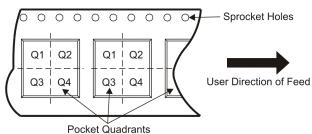
#### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

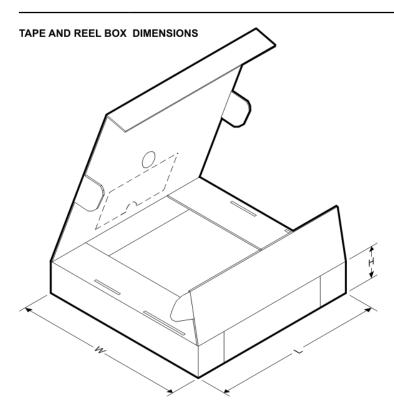
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16540ADGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
SN74ABT16540ADGVR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1
SN74ABT16540ADLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1

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#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT16540ADGGR	TSSOP	DGG	48	2000	346.0	346.0	41.0
SN74ABT16540ADGVR	TVSOP	DGV	48	2000	346.0	346.0	33.0
SN74ABT16540ADLR	SSOP	DL	48	1000	346.0	346.0	49.0



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